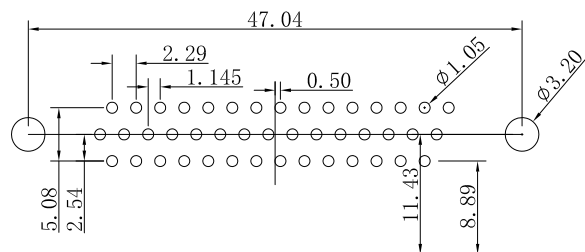
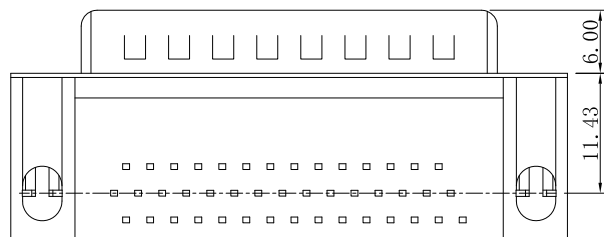
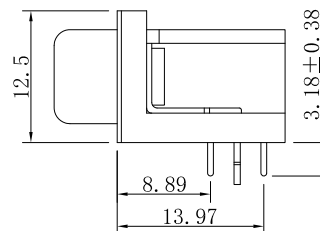


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements



PCB layout

Specification Type(1:2)				
A	B	C	D	E

CHARACTERISTICS:

- 1、RATED VOLTAGE: 250V
- 2、RATED CURRENT: 3.0AMP
- 3、CONTACT RESISTANCE: 30mΩ Max.
- 4、INSULATION RESISTANCE: 1000 MΩ MIN. 500V DC
- 5、Electric Pressure: Keeping 60 second in AC 500V/1mA
- 6、Operating temperature: -55℃~105℃
- 7、INSERTION/EXTRACTION FORCE PER CONTACT: 9.08Kg Max  
0.78Kg Min.

ORDER INFORMATION

P/N:WLDBM9-441XXX064	
Number of Contact	SCREW
Contact Type 1: DIP	A: Specification Type A B: Specification Type B C: Specification Type C D: Specification Type D E: Specification Type E
Plating Contact 1: Gold Flash 3: Au: 3U" 6: Au: 30U"	Housing color A: Black S: Nature

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART. NO:	DWG. NO:	 WanLian Teconology Co., Ltd
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.03.11	WLDBM9-441XXX064	ENDE05	
			UNIT: mm	0.0±0.35	X° REF±6°	DESIGNER	Ding_Bo	21.03.11	TITLE: HDR 44M 8.89 90° DIP		REV: A0    SHEET: 1/1
				0.00±0.25	X° ±3°	DRAWN	Ou_Jian	21.03.11			
			SIZE: A4	0.000±0.10	X° X'±2°						